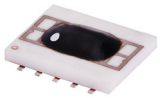
X2 Frequency Multiplier

KC2-19+

50Ω Output 2200 to 3800 MHz



Generic photo used for illustration purposes only

CASE STYLE: DZ885

+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

Maximum Ratings

Operating Temperature	-55°C to 100°C
Storage Temperature	-55°C to 100°C
RF Input, 25°C	200mW

Permanent damage may occur if any of these limits are exceeded.

Pin Connections

INPUT	10
OUTPUT	5
50Ω TERMINATE EXT.	3
GROUND	1,2,4,6,7,8,9

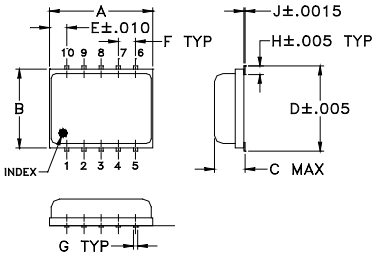
Features

- low conversion loss, 10.5 dB typ.
- LTCC design
- low profile, 0.085”
- low cost

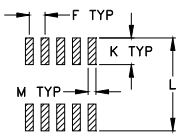
Applications

- synthesizers
- local oscillators

Outline Drawing



PCB Land Pattern

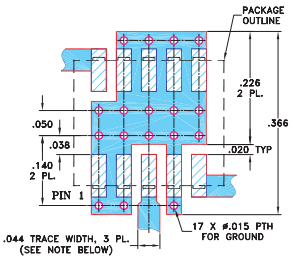


Suggested Layout,
Tolerance to be within ±.002

Outline Dimensions (inch / mm)

A	B	C	D	E	F	G
.30	.250	.085	.266	.050	.050	.012
7.62	6.35	2.16	6.76	1.27	1.27	0.30
H	**J**	**K**	**L**	**M**		**wt**
.029	.004	.085	.296	.030		grams
0.74	0.10	2.16	7.52	0.76		0.25

Demo Board MCL P/N: TB-144
Suggested PCB Layout (PL-045)



NOTES: 1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .020" ± .0015"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

Electrical Specifications

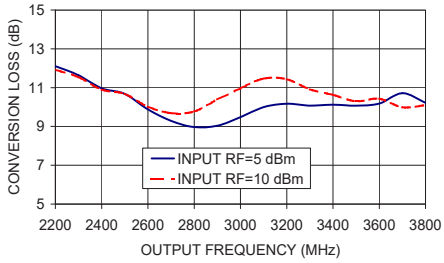
MULTIPLICATION FACTOR	FREQUENCY (MHz)		INPUT POWER (dBm)		CONVERSION LOSS (dB)		*HARMONIC OUTPUT (dBc)					
	F1	F2					F1		F3		F4	
	Input	Output	Min.	Max.	Typ.	Max.	Typ.	Min.	Typ.	Min.	Typ.	Min.
2	1100-1900	2200-3800	5	10	10.5	14.6	24	18	30	18	17	12

* Harmonics of input frequency below the power level of F2

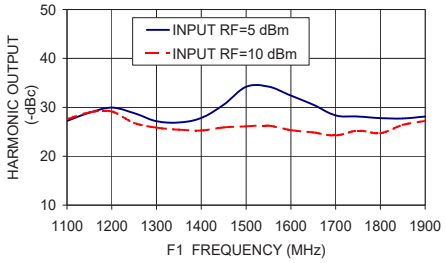
Typical Performance Data

Input Frequency (MHz)	INPUT RF= 5 dBm Conversion Loss (dB)	INPUT RF= 5 dBm Harmonic Output Below F2 (-dBc) F1	F3	F4	INPUT RF= 10 dBm Conversion Loss (dB)	INPUT RF= 10 dBm Harmonic Output Below F2 (-dBc) F1	F3	F4
1100.00	12.11	27.22	26.90	24.09	11.92	27.59	25.53	18.60
1200.00	10.96	29.96	29.37	30.10	10.90	29.15	29.02	17.70
1300.00	9.88	27.15	39.80	29.28	10.02	25.85	35.46	20.19
1400.00	8.97	27.83	40.01	22.24	9.77	25.27	38.18	17.75
1500.00	9.48	34.22	38.00	19.75	10.96	26.11	40.72	16.17
1550.00	10.00	34.23	37.86	21.15	11.46	26.25	41.21	16.88
1600.00	10.17	32.42	33.61	23.26	11.43	25.32	40.61	16.41
1650.00	10.07	30.54	33.01	25.89	10.91	24.88	36.81	17.03
1700.00	10.12	28.35	32.01	27.07	10.63	24.25	37.51	17.60
1750.00	10.07	28.10	30.86	24.69	10.30	25.22	37.99	20.05
1800.00	10.18	27.80	28.28	23.96	10.43	24.71	34.18	23.83
1850.00	10.71	27.71	28.58	26.17	9.99	26.42	33.97	26.09
1900.00	10.22	28.10	30.19	30.17	10.10	27.22	33.59	30.26

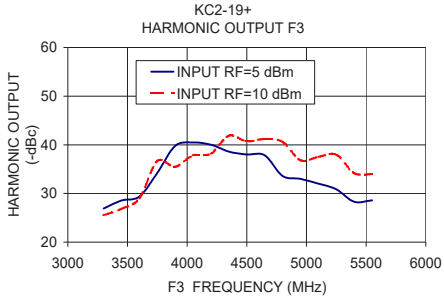
KC2-19+
CONVERSION LOSS



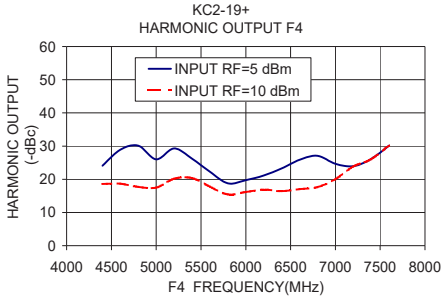
KC2-19+
HARMONIC OUTPUT F1



KC2-19+
HARMONIC OUTPUT F3



KC2-19+
HARMONIC OUTPUT F4



Notes

A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp

REV. C
M151107
KC2-19+
ED-11593/3
DJ/RS/CP/AM
200512

Frequency Multiplier (Doubler) KC2-19+

Typical Performance Data

FREQUENCY (MHz)				RF IN=+5dBm			
				CONVERSION LOSS (dB)	HARMONIC OUTPUT* (-dBc)		
X 1 OUTPUT	X 2 OUTPUT	X 3 OUTPUT	X 4 OUTPUT	X 2 OUTPUT	X 1 OUTPUT	X 3 OUTPUT	X 4 OUTPUT
1100	2200	3300	4400	12.11	27.22	26.90	24.09
1150	2300	3450	4600	11.64	28.91	28.56	28.91
1200	2400	3600	4800	10.96	29.96	29.37	30.10
1250	2500	3750	5000	10.68	28.82	34.21	26.01
1300	2600	3900	5200	9.88	27.15	39.80	29.28
1350	2700	4050	5400	9.29	26.91	40.49	26.19
1400	2800	4200	5600	8.97	27.83	40.01	22.24
1450	2900	4350	5800	9.04	30.55	38.61	18.78
1500	3000	4500	6000	9.48	34.22	38.00	19.75
1550	3100	4650	6200	10.00	34.23	37.86	21.15
1600	3200	4800	6400	10.17	32.42	33.61	23.26
1650	3300	4950	6600	10.07	30.54	33.01	25.89
1700	3400	5100	6800	10.12	28.35	32.01	27.07
1750	3500	5250	7000	10.07	28.10	30.86	24.69
1800	3600	5400	7200	10.18	27.80	28.28	23.96
1850	3700	5550	7400	10.71	27.71	28.58	26.17
1900	3800	5700	7600	10.22	28.10	30.19	30.17

*Harmonic Output below power level of X 2 Output .

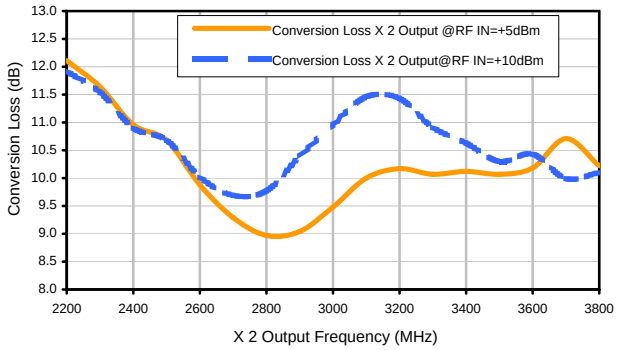
FREQUENCY (MHz)				RF IN=+10dBm			
				CONVERSION LOSS (dB)	HARMONIC OUTPUT* (-dBc)		
X 1 OUTPUT	X 2 OUTPUT	X 3 OUTPUT	X 4 OUTPUT	X 2 OUTPUT	X 1 OUTPUT	X 3 OUTPUT	X 4 OUTPUT
1100	2200	3300	4400	11.92	27.59	25.53	18.60
1150	2300	3450	4600	11.54	28.98	26.84	18.69
1200	2400	3600	4800	10.90	29.15	29.02	17.70
1250	2500	3750	5000	10.68	26.81	36.66	17.47
1300	2600	3900	5200	10.02	25.85	35.46	20.19
1350	2700	4050	5400	9.69	25.43	37.84	20.36
1400	2800	4200	5600	9.77	25.27	38.18	17.75
1450	2900	4350	5800	10.39	25.90	41.85	15.47
1500	3000	4500	6000	10.96	26.11	40.72	16.17
1550	3100	4650	6200	11.46	26.25	41.21	16.88
1600	3200	4800	6400	11.43	25.32	40.61	16.41
1650	3300	4950	6600	10.91	24.88	36.81	17.03
1700	3400	5100	6800	10.63	24.25	37.51	17.60
1750	3500	5250	7000	10.30	25.22	37.99	20.05
1800	3600	5400	7200	10.43	24.71	34.18	23.83
1850	3700	5550	7400	9.99	26.42	33.97	26.09
1900	3800	5700	7600	10.10	27.22	33.59	30.26

*Harmonic Output below power level of X 2 Output .

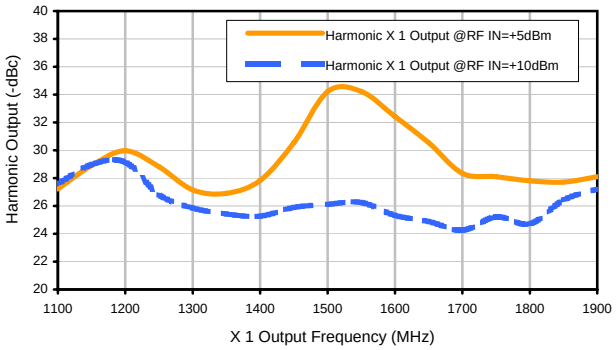
Frequency Multiplier (Doubler) KC2-19+

Typical Performance Curves

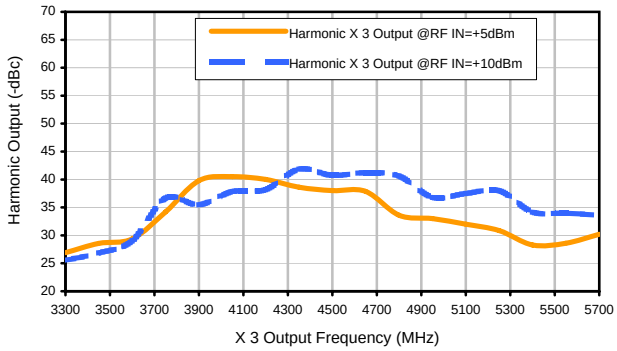
Conversion Loss X 2 Output



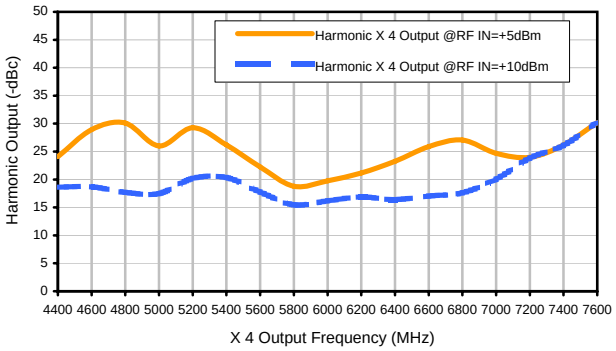
Harmonic X 1 Output



Harmonic X 3 Output



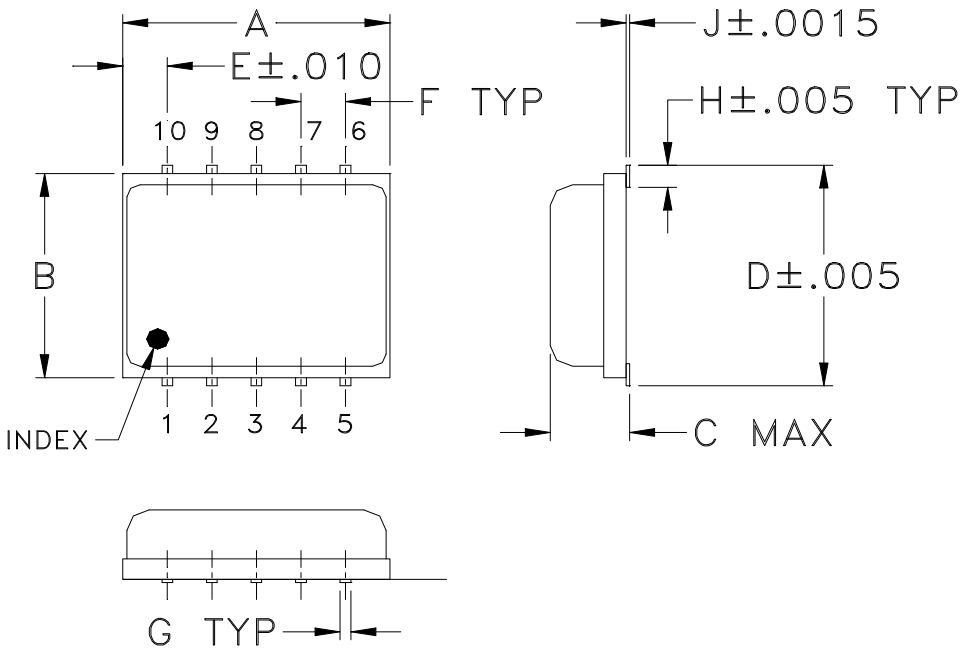
Harmonic X 4 Output



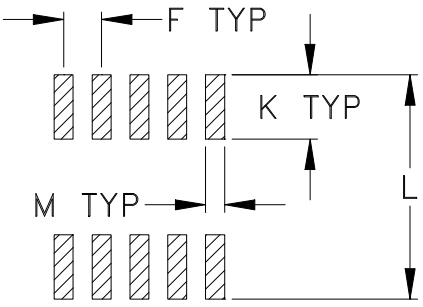
Case Style DZ

DZ885
DZ1034

Outline Dimensions



PCB Land Pattern



Suggested Layout,
Tolerance to be within ±.002

CASE#	A	B	C	D	E	F	G	H	J	K	L	M	WT. GRAMS
DZ885	.30 (7.62)	.250 (6.35)	.085 (2.16)	.266 (6.76)	.050 (1.27)	.050 (1.27)	.012 (0.30)	.029 (0.74)	.004 (0.10)	.085 (2.16)	.296 (7.52)	.030 (0.76)	0.25
DZ1034			.105 (2.67)										0.3

Dimensions are in inches (mm). Tolerances: 2Pl. ± .01; 3Pl. ± .005

Notes:

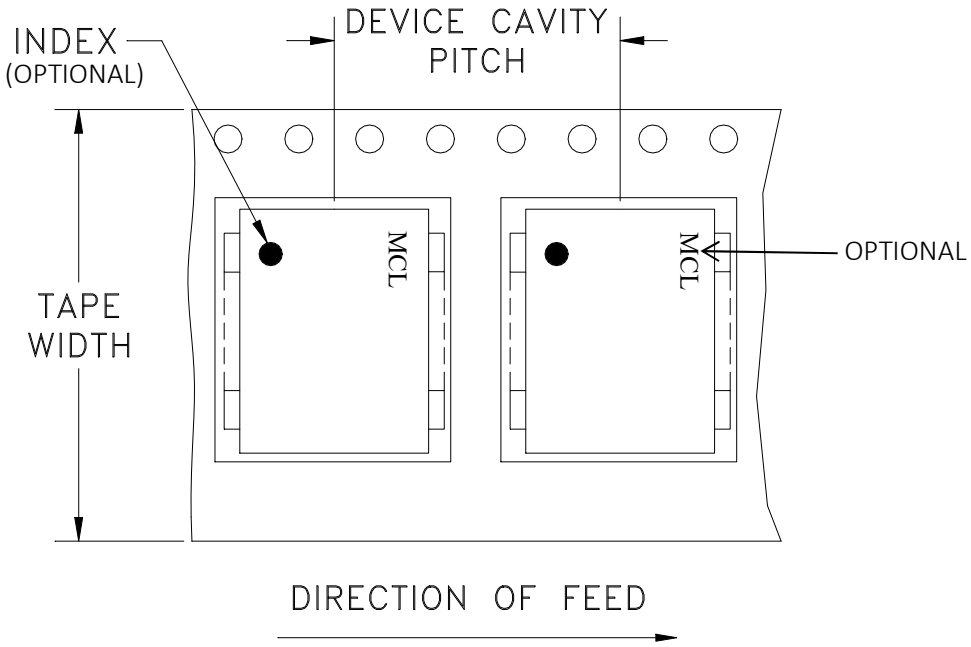
1. Case material: Plastic encapsulation on Ceramic base.
2. Termination finish:
   For RoHS Case Styles: Tin plate. All models, (+) suffix.
   For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.

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Tape & Reel Packaging TR-F34

DEVICE ORIENTATION IN T&R



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel see note	
16	12	7	Small quantity standard (see note)	20
				50
				100
				200
		13	Standard	500
				1000

Note: Availability of small reel quantity varies by model.
Refer to pricing and availability on individual model dashboard.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf

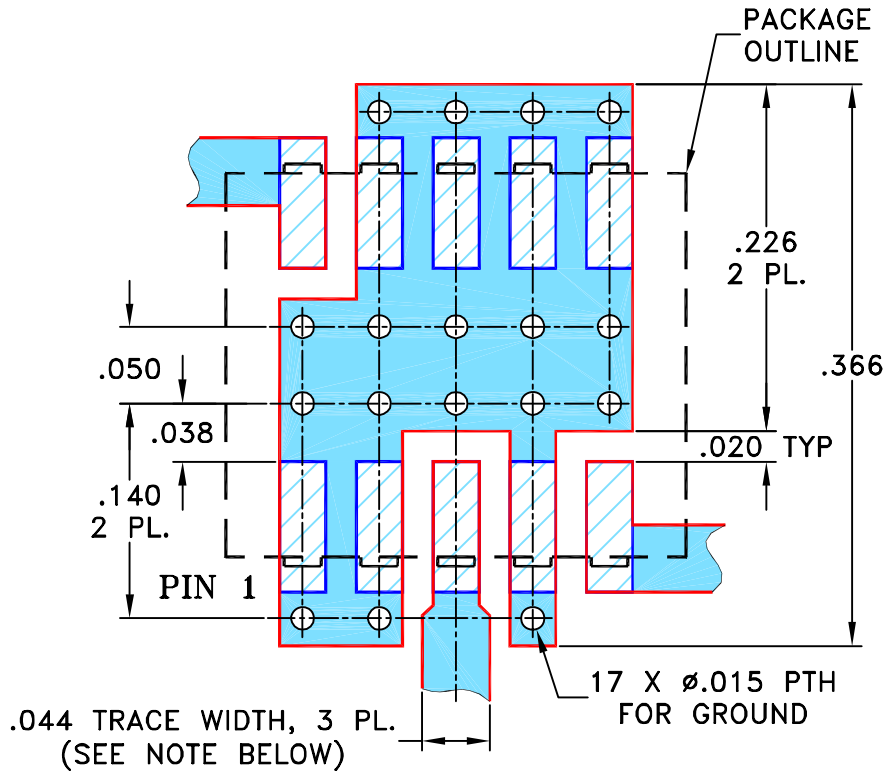
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THIRD ANGLE PROJECTION

REVISIONS					
REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
A	M81781	UPDATED PCB LAYOUT	06/07/02	GF	DJ
B	M82377	UPDATED DRAWING	07/31/02	AV	WL
C	M102713	ADDED NOTE 2 & "...WITH SMOBC"	01/17/06	MMG	IL
D	M135488	ADDED DZ1650, CHANGED PIN CONN.	02/02/12	GF	DJ

SUGGESTED MOUNTING CONFIGURATION FOR DZ883, DZ885 & DZ1650 CASE STYLES, "10MX01" PIN CONNECTION



NOTES:
1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .020" ± .0015"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED		INITIALS	DATE
DIMENSIONS ARE IN INCHES	DRAWN	AV	05/08/02
TOLERANCES ON:	CHECKED	DB	05/16/02
2 PL DECIMALS ±	APPROVED	WL	05/16/02
3 PL DECIMALS ± .005			
ANGLES ±			
FRACTIONS ±			

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ASHEETA1.DWG REV:A DATE:01/12/95

Mini-Circuits® 13 Neptune Avenue Brooklyn NY 11235

PL, 10MX01, DZ883/885/1650, TB-144

SIZE	CODE IDENT	DRAWING NO:	REV:
A	15542	98-PL-045	D

FILE:	SCALE:	SHEET:
98PL045	8:1	1 OF 1

Mini-Circuits

Environmental Specifications ENV10

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 100°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Autoclave	15 psig, 100% RH, 121°C, 96 hours	JESD22-A102-C, Condition C
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutectic Process: 225°C peak Pb-Free Process: 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2; Figure 5-1
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215

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